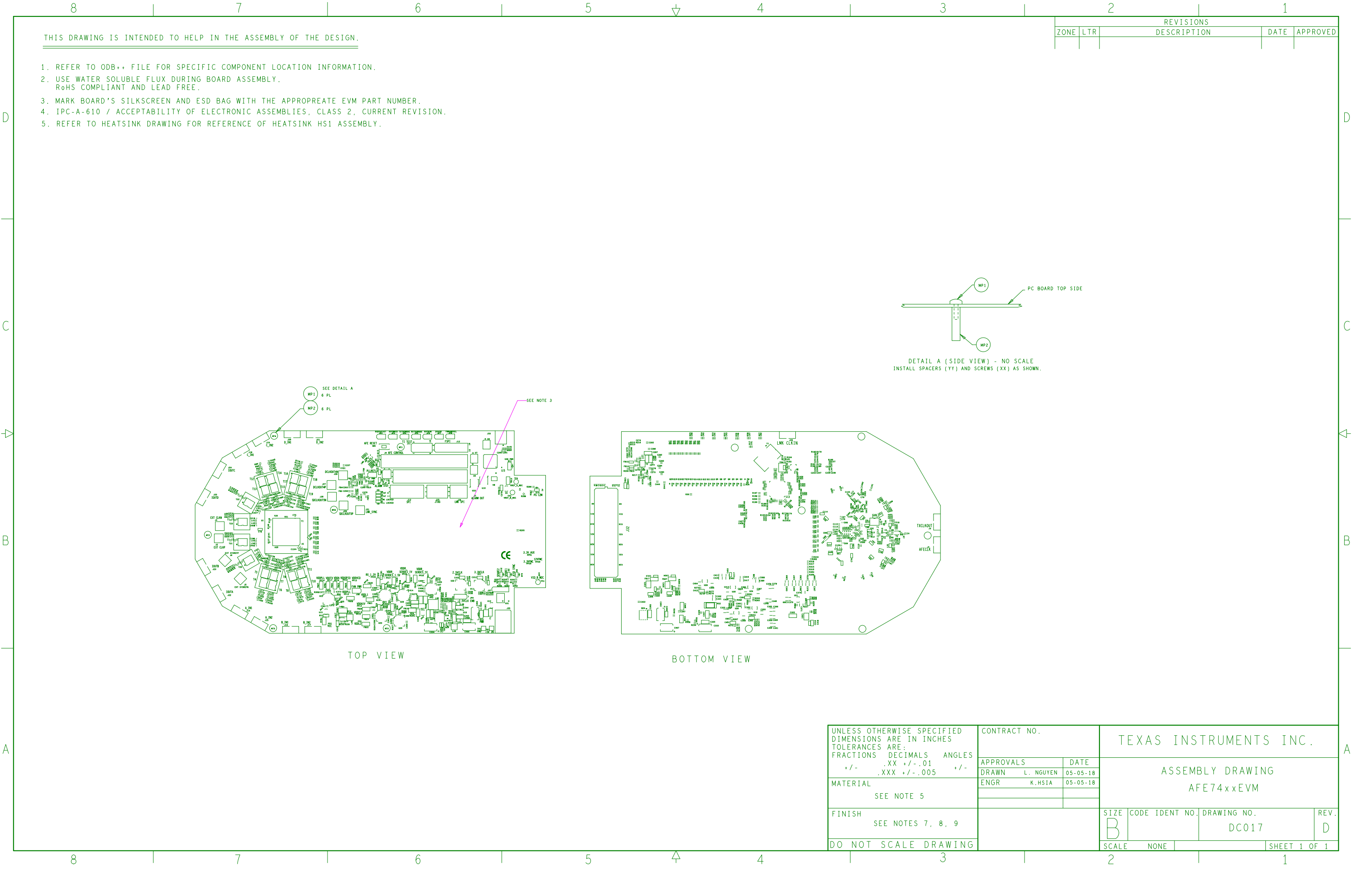
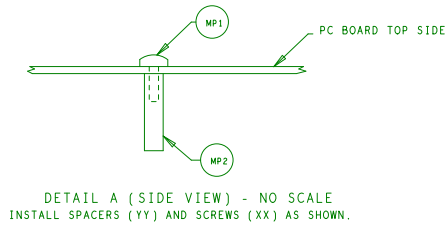




THIS DRAWING IS INTENDED TO HELP IN THE ASSEMBLY OF THE DESIGN.

1. REFER TO ODB++ FILE FOR SPECIFIC COMPONENT LOCATION INFORMATION.
2. USE WATER SOLUBLE FLUX DURING BOARD ASSEMBLY.
RoHS COMPLIANT AND LEAD FREE.
3. MARK BOARD'S SILKSCREEN AND ESD BAG WITH THE APPROPREATE EVM PART NUMBER.
4. IPC-A-610 / ACCEPTABILITY OF ELECTRONIC ASSEMBLIES, CLASS 2, CURRENT REVISION.
5. REFER TO HEATSINK DRAWING FOR REFERENCE OF HEATSINK HS1 ASSEMBLY.



UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES TOLERANCES ARE: FRACTIONS DECIMALS ANGLES +/- .XX +/- .01 +/- .XXX +/- .005 +/-	CONTRACT NO.		TEXAS INSTRUMENTS INC.				
	APPROVALS		DATE		ASSEMBLY DRAWING AFE74xxEVM		
	DRAWN L. NGUYEN		05-05-18				
ENGR K.HSIA		05-05-18					
MATERIAL							
SEE NOTE 5							
FINISH			SIZE	CODE IDENT NO.	DRAWING NO.	REV.	
SEE NOTES 7, 8, 9			B		DC017	D	
DO NOT SCALE DRAWING			SCALE	NONE		SHEET 1 OF 1	